

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	2	("20040026792").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/07/24 21:31
L2	403023	filler	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/07/24 21:33
L4	2089100	upward\$ rise rises rising float\$	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/07/24 21:34
L5	5014	2 with 4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/07/24 21:34
L6	1806682	underfil\$ resin	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/07/24 21:35
L7	352	5 with 6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/07/24 21:35
L8	1970555	semiconductor integrated adj circuit ic "438"/\$.ccls. "257"/\$. ccls. "228"/\$.ccls.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/07/24 21:35
L9	53	7 and 8	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/07/24 21:50
L10	2094	228/180.22:257/737;"738" 438/612-617;"118"	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/07/24 21:52

L11	0	7 and 10	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/07/24 21:52
L12	1	5 and 10	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/07/24 21:52